

FEATURES

1	Surface	Mounting	Desian	4 5*3	2*27mm
	Sanace	mouning	Design	1.5 5	~ ~ ~ . /

- High Current Handling Capability 2000A @ 8/20 µs
- Low Capacitance and Insertion Loss
- Quick Response and Long Service Life
- Moisture sensitivity level: Level 1





APPLICATION INFORMATION

Communication equipment.

- Repeaters,Modems
- Telephone Interface,Line cards.

Data communication equipment.

AGENCY APPROVALS

lcon	Solderability	
RoHS	Compliance with 2011/65/EU	
HF	Compliance with IEC61249-2-21:2003	
Pb	Mean lead free	
LR.	UL Certificated E505857	

PRODUCT CHARACTERISTICS

Lead Material	Body Material	Terminal Finish
Copper or Fe-Ni alloy	Ceramics	100% Matte-Tin Plated



ELECTRICAL PARAMETER

Parameter	Condition	Rating	Unit
DC Blocking Voltage 1)	100V/s	49-91	V
Impulse Spark-over Voltage	At 1kV/µs	for 99 % of measured values ≤ 700	V
	At 1kV/μs	Typical values of distribution ≤ 600	V
Impulse Discharge Current 2)	8/20µs	2000	A
Insulation Resistance	DC=50V	≥ 1	GΩ
Capacitance at 1MHz	V _{DC} =0.5V	≤ 1.0	pF
Operating And Storage Temperature		-40-125	°C

1) In ionized mode

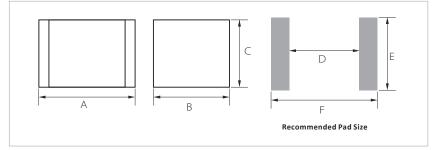
2) Terms and waveforms in accordance with ITU-T Rec. K. 12; IEC 61643-311

ENVIRONMENTAL RELIABILITY CHARACTERISTICS

Testing items	Technical standards	
High Temperature Storage Test Temperature: 85°C ; Time:2H		
Low Temperature Storage Test	Temperature: -40°C ; Time:2H	
Vibration	Frequency: 10-500Hz ; Amplitude: 0.15mm ; Time:45min	
Resistance of soldering heat	Temperature: 260±5°C; Time of dip soldering: 10s, 1time	

NOTE: Up-screen program can be specified by customer's request via contacting Semiware service

PRODUCT DIMENSIONS AND RECOMMENDED SOLDERING PAD



Ref.	mm
A	4.5±0.3mm
В	3.2±0.3mm
С	2.7±0.3mm
D	2.8mm
E	4.0mm
F	5.2mm



SOLDERABILITY TEST

Solderability		
Solder Pot Temperature	Solder Dwell Time	
245°C ± 5°C	4-6 seconds	

REFLOW PROFILE

	Reflow Condition	Lead-free assembly
	Temperature Min	150°C
Pre Heat	Temperature Max	200°C
	Time(min to max)	60 – 180 secs
Average ramp up rate (Liquidus)Temp (T_L) to peak		3°C/second max
T _{s(max)} to T _L - Ramp-up Rate		5 C/ 300011110
	Temperature (T _L) (Liquidus)	217°C
Reflow	Time(min to max)(t _s)	60 – 150 seconds
Peak Temperature (T _p)		260 °C
Time with	in 5°C of actual peak Temperature (tp)	20-40 seconds
Ramp-down Rate		6°C/second max
Time 25°C to peak Temperature (T $_{p}$)		8 minutes max.
Do not exceed		260°C

ORDERING INFORMATION

Part Number	Size	QTY/Reel	Reel Size
SG4532B070	4.5*3.2*2.7mm	2500PCS	13″



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By QR Code





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